

MJD122, NJVMJD122 (NPN), MJD127, NJVMJD127 (PNP)

Complementary Darlington Power Transistor

DPAK For Surface Mount Applications

Designed for general purpose amplifier and low speed switching applications.

Features

- Lead Formed for Surface Mount Applications in Plastic Sleeves
- Surface Mount Replacements for 2N6040–2N6045 Series, TIP120–TIP122 Series, and TIP125–TIP127 Series
- Monolithic Construction With Built-in Base–Emitter Shunt Resistors
- High DC Current Gain: $h_{FE} = 2500$ (Typ) @ $I_C = 4.0$ Adc
- Epoxy Meets UL 94 V–0 @ 0.125 in
- ESD Ratings:
 - ♦ Human Body Model, $3B > 8000$ V
 - ♦ Machine Model, $C > 400$ V
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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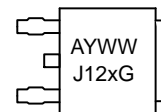
**SILICON
POWER TRANSISTOR
8 AMPERES
100 VOLTS, 20 WATTS**



**DPAK
CASE 369C
STYLE 1**



MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
x = 2 or 7
G = Pb–Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|----------------|---------------|--------------------------|
| Collector–Emitter Voltage | V_{CEO} | 100 | Vdc |
| Collector–Base Voltage | V_{CB} | 100 | Vdc |
| Emitter–Base Voltage | V_{EB} | 5 | Vdc |
| Collector Current Continuous Peak | I_C | 8 16 | Adc |
| Base Current | I_B | 120 | mAdc |
| Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C | P_D | 20 0.16 | W W/ $^\circ\text{C}$ |
| Total Power Dissipation (Note 1) @ $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 1.75 0.014 | W W/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range | T_J, T_{stg} | -65 to +150 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|------|--------------------|
| Thermal Resistance, Junction–to–Case | $R_{\theta JC}$ | 6.25 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction–to–Ambient (Note1) | $R_{\theta JA}$ | 71.4 | $^\circ\text{C/W}$ |

1. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|----------------|--------|-----|-----|------|
|----------------|--------|-----|-----|------|

OFF CHARACTERISTICS

| | | | | |
|--|---------------|-----|----|-----------------|
| Collector–Emitter Sustaining Voltage ($I_C = 30\text{ mAdc}$, $I_B = 0$) | $V_{CE(sus)}$ | 100 | – | Vdc |
| Collector Cutoff Current ($V_{CE} = 50\text{ Vdc}$, $I_B = 0$) | I_{CEO} | – | 10 | μAdc |
| Collector Cutoff Current ($V_{CB} = 100\text{ Vdc}$, $I_E = 0$) | I_{CBO} | – | 10 | μAdc |
| Emitter Cutoff Current ($V_{BE} = 5\text{ Vdc}$, $I_C = 0$) | I_{EBO} | – | 2 | mAdc |

ON CHARACTERISTICS

| | | | | |
|--|---------------|-------------|-------------|-----|
| DC Current Gain ($I_C = 4\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$) ($I_C = 8\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$) | h_{FE} | 1000 100 | 12,000 – | – |
| Collector–Emitter Saturation Voltage ($I_C = 4\text{ Adc}$, $I_B = 16\text{ mAdc}$) ($I_C = 8\text{ Adc}$, $I_B = 80\text{ mAdc}$) | $V_{CE(sat)}$ | – – | 2 4 | Vdc |
| Base–Emitter Saturation Voltage (Note 2) ($I_C = 8\text{ Adc}$, $I_B = 80\text{ mAdc}$) | $V_{BE(sat)}$ | – | 4.5 | Vdc |
| Base–Emitter On Voltage ($I_C = 4\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$) | $V_{BE(on)}$ | – | 2.8 | Vdc |

DYNAMIC CHARACTERISTICS

| | | | | |
|---|------------|--------|------------|-----|
| Current–Gain–Bandwidth Product ($I_C = 3\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$, $f = 1\text{ MHz}$) | $ h_{fe} $ | 4 | – | MHz |
| Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 0.1\text{ MHz}$) MJD127, NJVMJD127 MJD122, NJVMJD122 | C_{ob} | – – | 300 200 | pF |
| Small–Signal Current Gain ($I_C = 3\text{ Adc}$, $V_{CE} = 4\text{ Vdc}$, $f = 1\text{ kHz}$) | h_{fe} | 300 | – | – |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2\%$.



Figure 1. Power Derating

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TYPICAL ELECTRICAL CHARACTERISTICS



Figure 2. DC Current Gain



Figure 3. Collector Saturation Region



Figure 4. "On" Voltages

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TYPICAL ELECTRICAL CHARACTERISTICS



Figure 5. Temperature Coefficients



Figure 6. Collector Cut-Off Region



Figure 7. Small-Signal Current Gain



Figure 8. Capacitance

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Figure 9. Switching Times Test Circuit



Figure 10. Switching Times



Figure 11. Thermal Response



Figure 12. Maximum Forward Bias Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 12 is based on $T_{J(pk)} = 150^\circ\text{C}$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150^\circ\text{C}$. $T_{J(pk)}$ may be calculated from the data in Figure 11. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

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Figure 13. Darlington Schematic

ORDERING INFORMATION

| Device | Package Type | Shipping† |
|---------------|-------------------|---------------------|
| MJD122G | DPAK (Pb-Free) | 75 Units / Rail |
| MJD122T4G | DPAK (Pb-Free) | 2,500 / Tape & Reel |
| NJVMJD122T4G* | DPAK (Pb-Free) | 2,500 / Tape & Reel |
| MJD127G | DPAK (Pb-Free) | 75 Units / Rail |
| MJD127T4G | DPAK (Pb-Free) | 2,500 / Tape & Reel |
| NJVMJD127T4G* | DPAK (Pb-Free) | 2,500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

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PACKAGE DIMENSIONS

DPAK (SINGLE GAUGE) CASE 369C ISSUE F

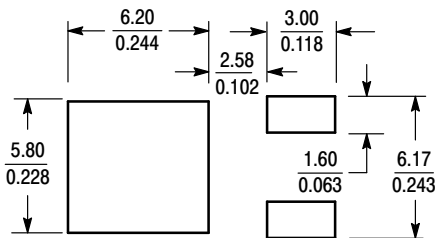


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.
7. OPTIONAL MOLD FEATURE.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.086 | 0.094 | 2.18 | 2.38 |
| A1 | 0.000 | 0.005 | 0.00 | 0.13 |
| b | 0.025 | 0.035 | 0.63 | 0.89 |
| b2 | 0.028 | 0.045 | 0.72 | 1.14 |
| b3 | 0.180 | 0.215 | 4.57 | 5.46 |
| c | 0.018 | 0.024 | 0.46 | 0.61 |
| c2 | 0.018 | 0.024 | 0.46 | 0.61 |
| D | 0.235 | 0.245 | 5.97 | 6.22 |
| E | 0.250 | 0.265 | 6.35 | 6.73 |
| e | 0.090 BSC | | 2.29 BSC | |
| H | 0.370 | 0.410 | 9.40 | 10.41 |
| L | 0.055 | 0.070 | 1.40 | 1.78 |
| L1 | 0.114 REF | | 2.90 REF | |
| L2 | 0.020 BSC | | 0.51 BSC | |
| L3 | 0.035 | 0.050 | 0.89 | 1.27 |
| L4 | --- | 0.040 | --- | 1.01 |
| Z | 0.155 | --- | 3.93 | --- |

SOLDERING FOOTPRINT*



SCALE 3:1 (mm/inches)

STYLE 1:

1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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